

# 2 x 45W Stereo Single-Ended or 90W Mono BTL Class-D Audio Amplifier

The Future of Analog IC Technology

#### **DESCRIPTION**

MP7770 is an analog class-D audio amplifier that can drive either stereo speakers in single-ended configuration or a mono speaker in a bridge-tied-load configuration. It is part of MPS's family of fully-integrated audio amplifiers that dramatically reduce footprint size by integrating:

- 100mΩ power MOSFETs
- Startup/Shutdown pop elimination
- Short-circuit protection circuits

The MP7770 is capable of delivering 45W per channel into  $4\Omega$  speaker in single-ended output structure, or delivering 90W into  $8\Omega$  speaker in bridge-tied-load output structure under 36V VDD. MPS's class D audio amplifiers exhibit the high fidelity of a Class A/B amplifier at higher efficiencies. The circuit is based on the MPS's proprietary variable-frequency topology, which delivers excellent linearity, fast response time and operates from a single power supply.

#### **FEATURES**

- 9.5V-to-36V Operation from a Single Supply
- ±8.5A Peak Current Output
- Output Power at 36V and 10%THD:
  - Stereo Single-Ended: 2 x 45W into 4Ω Load,
  - Bridge-Tied Load: 90W into 8Ω Load
- THD+N = 0.03% at 1W, 8Ω
- > 90% Efficiency at 10%THD
- Low Noise
- Switching Frequency of up to 1MHz
- Integrated Startup and Shutdown Pop Elimination Circuit
- Programmable UVP
- Thermal and Short-Circuit Protection
- Output Fault Flag and Thermal Warning
- Integrated Power FETs
- TSSOP28-EP Package with Exposed Pad

#### **APPLICATIONS**

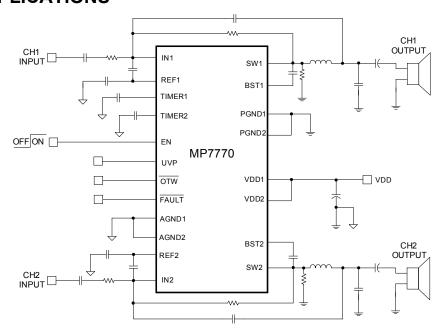
- DVD Receiver
- Mini Combo System
- Home Theater Systems
- Surround Sound Systems
- Audio Docking or High-Power Sound Box

All MPS parts are lead-free and adhere to the RoHS directive. For MPS green status, please visit MPS website under Quality Assurance

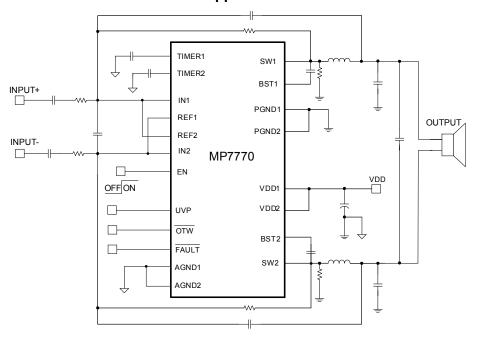
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# **TYPICAL APPLICATIONS**



# **Stereo SE Application Circuit**



**Mono BTL Application Circuit** 



#### ORDERING INFORMATION

Part Number*	Package	Top Marking	
MP7770GF	TSSOP28-EP	See Below	

<sup>\*</sup> For Tape & Reel, add suffix -Z (e.g. MP7770GF-Z);

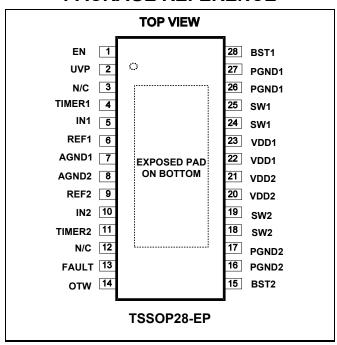
# **TOP MARKING (MP7770GF)**

MPSYYWW MP7770 LLLLLLLL

MP7770: product code of MP7770GF;

MPS: MPS prefix; Y: year code; WW: week code: LLL: lot number;

#### PACKAGE REFERENCE





# **ABSOLUTE MAXIMUM RATINGS (1)**

Supply Voltage V <sub>DD</sub>	
BS Voltage(V <sub>SW</sub> - 0.3V	') to (V <sub>SW</sub> + 6.5V)
$V_{OTW}$ , $V_{FAULT}$ , $V_{UVP}$ , $V_{TIMER}$ , $V_{EN}$	–0.3V to +6V
V <sub>SW</sub> 0	.3V to $(V_{DD} + 1V)$
V <sub>REF</sub> , V <sub>IN</sub>	0.3V to +34V
AGND to PGND	
Continuous Power Dissipation (	$(T_A = 25^{\circ}C)^{(2)}$
Junction Temperature	
Lead Temperature	
Storage Temperature	–65°C to +150°C
Recommended Operating (	Conditions (3)
Supply Voltage V <sub>DD</sub>	
Operating Junction Temp. (T <sub>J</sub> )	
	-40°C to +125°C

Thermal Resistance <sup>(4)</sup>	$oldsymbol{ heta}_{JA}$	$oldsymbol{ heta}_{JC}$	
TSSOP28-EP	32	6	°C/W

#### Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature  $T_J$  (MAX), the junction-to-ambient thermal resistance  $\theta_{JA}$ , and the ambient temperature  $T_A$ . The maximum allowable continuous power dissipation at any ambient temperature is calculated by  $P_D$  (MAX) = ( $T_J$  (MAX)- $T_A$ )/ $\theta_{JA}$ . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.



# **ELECTRICAL CHARACTERISTICS (5, 6)**

 $V_{DD}$  = 24V,  $V_{EN}$  = 5V,  $T_A$  = 25°C, unless otherwise noted.

Parameters	Symbol	Condition	Min	Тур	Max	Units
Standby Current		$V_{EN} = 0V,REF=IN=Float$		120	140	μΑ
Quiescent Current	ΙQ	SW=Low		3	4	mA
SW ON Resistance		Sourcing and Sinking		0.1	0.15	Ω
Short-Circuit Current		Sourcing and Sinking	6.2	8.5		Α
EN Enable Threshold Voltage		V <sub>EN</sub> Rising		1.4	2.0	V
EN Chable Theshold Voltage		V <sub>EN</sub> Falling	0.4	1.0		V
EN Enable Input Current		V <sub>EN</sub> = 5V		5		μΑ
External Under-Voltage Detection	V <sub>UVP</sub>		2	2.2	2.4	V
External Under-Voltage Detection Hysteresis Voltage	V <sub>Hys</sub>			0.3		V
Thermal Shutdown Trip Point (7)		T <sub>J</sub> Rising		150		°C
Thermal Shutdown Hysteresis <sup>(7)</sup>				20		°C
Thermal Warning Trip Point <sup>(7)</sup>				125		°C
Thermal Warning Hysteresis <sup>(7)</sup>				10		°C

- 5) The device is not guaranteed to function outside its operating rating.6) Electrical Characteristics are for the IC only with no external components except bypass capacitors.
- 7) Not production tested.



# **OPERATING SPECIFICATIONS** (8)

Circuit of Figure 6, Single-Ended Output Configuration;  $V_{DD}$  = 34V, Gain=8.2V/V;  $V_{EN}$  = 5V,  $T_A$  = 25°C, unless otherwise noted.

Parameters	Symbol	Condition		Min	Тур	Max	Units
Standby Current		V <sub>EN</sub> = 0V			120		μΑ
Quiescent Current		Switching, no load			29		mA
		f = 1kHz, THD+N =	10%, 4Ω Load		41		W
Bower Output		f = 1kHz, THD+N =	1%, 4Ω Load		32		W
Power Output		f = 1kHz, THD+N =	10%, 8Ω Load		22		W
		f = 1kHz, THD+N =	1%, 8Ω Load		17		W
THD + Noise		$P_{OUT}$ = 1W, f = 1kHz, 4Ω Load			0.05		%
I HD + Noise		$P_{OUT}$ = 1W, f = 1kHz, 8 $\Omega$ Load			0.03		%
Efficiency		$f = 1kHz$ , $P_{OUT} = 41W$ , $4\Omega$ Load			91		%
Efficiency		$f = 1kHz$ , $P_{OUT} = 22W$ , $8\Omega$ Load			95		%
Maximum Power Bandwidth					20		kHz
Dynamic Range					102		dB
Noise Floor		A-Weighted			90		μV
Dower Supply Rejection		V <sub>RIPPLE</sub> =300mV <sub>PP</sub>	f = 1k Hz		-60		dB
Power Supply Rejection		$C_R = 100 \mu F$ $f = 217 Hz$			-60		dB

# Circuit of Figure 7, BTL Output Configuration; $V_{DD}$ = 34V, Gain=15V/V; $V_{EN}$ = 5V, $T_A$ = 25°C, unless otherwise noted.

Parameters	Symbol	Condition	Condition		Тур	Max	Units
Standby Current		V <sub>EN</sub> = 0V			120		μΑ
Quiescent Current		Switching, no load			32		mA
Power Output		f = 1kHz, THD+N =	10%, 6Ω Load		108		W
Fower Output		f = 1kHz, THD+N =	1%,6Ω Load		83		W
THD+ Noise		$P_{OUT} = 1W, f = 1kHz$	z, 6Ω Load		0.06		%
ITID! Noise		$P_{OUT}$ = 1W, f = 1kHz, 8 $\Omega$ Load			0.04		%
Efficiency		$f = 1kHz$ , $P_{OUT} = 108W$ , $6Ω$ Load			91		%
Elliciency		$f = 1kHz$ , $P_{OUT} = 84W$ , $8Ω$ Load			95		%
Maximum Power Bandwidth					20		kHz
Dynamic Range					105		dB
Noise Floor		A-Weighted			120		μV
Dower Cumply Dejection		V <sub>RIPPLE</sub> =300mV <sub>PP</sub>	f = 1k Hz		-60		dB
Power Supply Rejection			f = 217 Hz		-60		dB

#### Note:

<sup>8)</sup> Operating Specifications are for the IC in Typical Application circuit (Figure 6 and Figure 7).



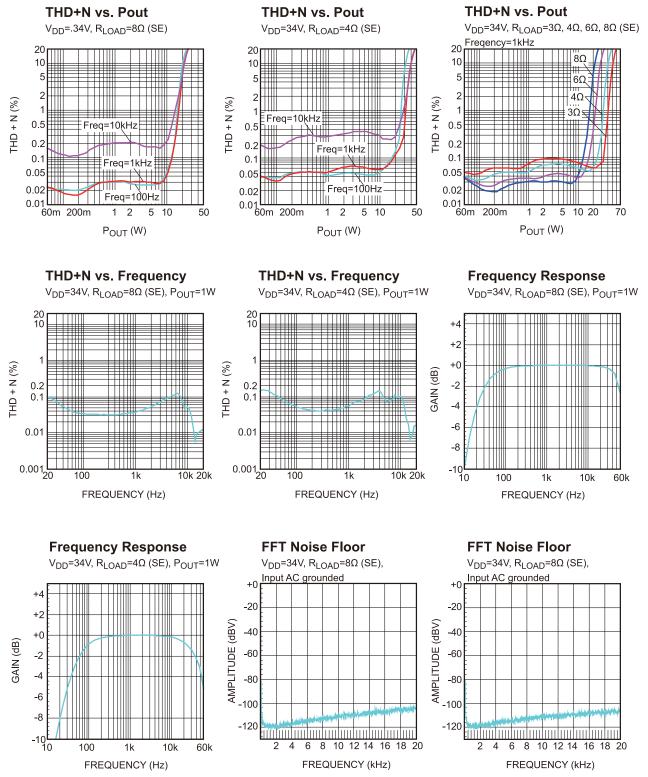
# **PIN FUNCTIONS**

EP on Bottom Pin #	Name	Description			
1	EN	Enable Input for Amplifier 1. Drive EN1 high to turn on the Amplifier 1, low to turn off.			
2	UVP	Under-Voltage Protection Reference Input.			
3, 12	N/C	Not Connected.			
4	TIMER1	Internal Timer Input for Amplifier 1. A capacitor from TIMER1 to AGND sets the internal timer which is used for start-up pop elimination.			
5	IN1	Inverting Input for Amplifier 1 .			
6	REF1	Internal Analog Reference (VDD/2) for Amplifier 1. For SE configuration, connect a bypass capacitor from REF1 to AGND ( $10\mu F$ ).			
7	AGND1	Analog Ground for Amplifier 1. Connect AGND1 to AGND2. Connect PGND to AGND at a single point.			
8	AGND2	Analog Ground for Amplifier 2. Connect AGND2 to AGND1.			
9	REF2	Internal Analog Reference (VDD/2) for Amplifier 2. For BTL configuration, connect a bypass capacitor from REF2 to AGND ( $10\mu F$ ).			
10	IN2	Inverting Input for Amplifier 2.			
11	TIMER2	Internal Timer Input for Amplifier 2. Use a capacitor from TIMER2 to AGND to set the internal timer for start-up pop elimination.			
13	FAULT	Fault Output. A low output at FAULT indicates that the IC has detected an over-temperature or over-current condition. This output is open drain.			
14	OTW	Over Temperature Warning. A low output at OTWB indicates that the die temperature rises above 125°C. This output is open drain.			
15	BST2	High-Side MOSFET Bootstrap Input for Amplifier 2. Connect a capacitor from BST2 to SW2 to supplies the gate drive to the internal High-Side MOSFET.			
16, 17	PGND2	Power Ground for Amplifier 2. Connect PGND2 to PGND1.			
18, 19	SW2	Switched Power Output for Amplifier 2.			
20, 21	VDD2	Power Supply Input for Amplifier 2. Bypass VDD2 to PGND2 with a $1\mu F$ X7R capacitor (in addition to the main bulk capacitor), placed close to the VDD2 and PGND2 pins.			
22, 23	VDD1	Power Supply Input for Amplifier 1. Bypass VDD1 to PGND1 with a $1\mu F$ X7R capacitor (in addition to the main bulk capacitor), placed close to the VDD1 and PGND1 pins.			
24, 25	SW1	Switched Power Output for Amplifier 1.			
26,27	PGND1	Power Ground for Amplifier 1. Connect PGND1 to PGND2. Connect PGND to AGND at a single point.			
28	BST1	High-Side MOSFET Bootstrap Input for Amplifier 1. A capacitor from BST1 to SW1 supplies the gate drive current to the internal High-Side MOSFET.			



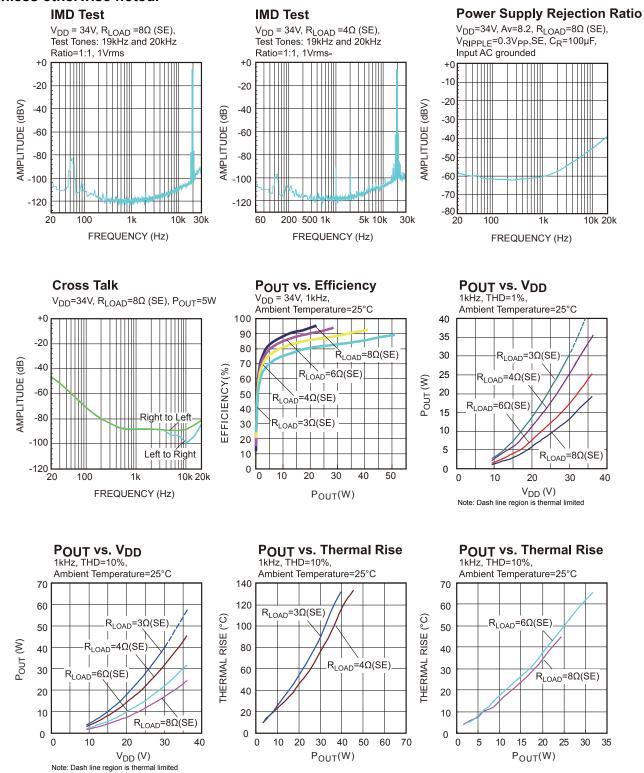
#### TYPICAL PERFORMANCE CURVES

Circuit of Figure 6, single-ended output configuration,  $V_{DD}$ =34V,  $V_{EN}$ =5V,  $A_V$ =8.2V/V,  $T_A$  = +25°C, unless otherwise noted.



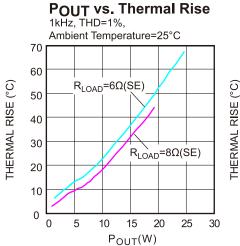


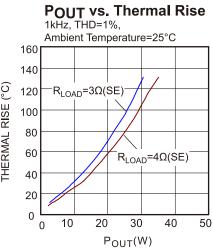
Circuit of Figure 6, single-ended output configuration,  $V_{DD}$ =34V,  $V_{EN}$ =5V,  $A_V$ =8.2V/V,  $T_A$  = +25°C, unless otherwise noted.





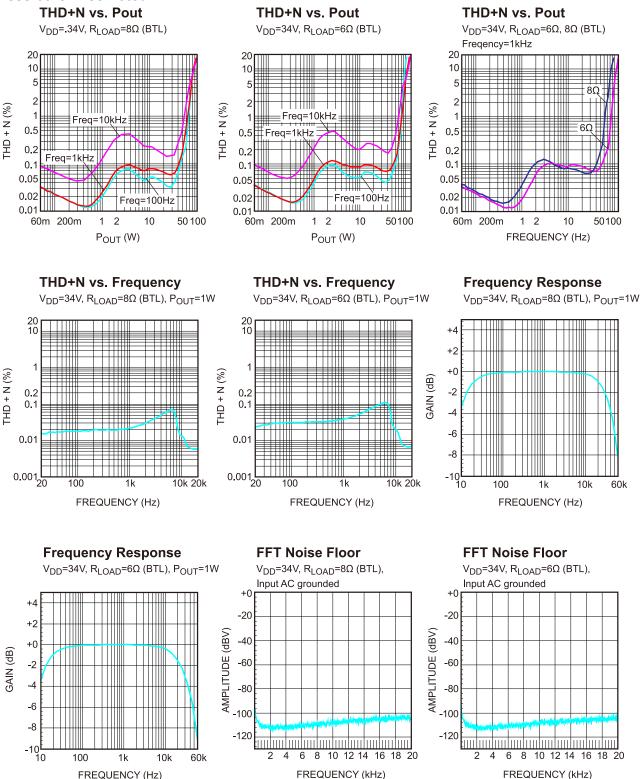
Circuit of Figure 6, single-ended output configuration,  $V_{DD}$ =34V,  $V_{EN}$ =5V,  $A_V$ =8.2V/V,  $T_A$  = +25°C, unless otherwise noted.





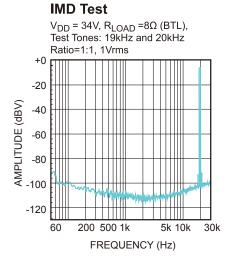


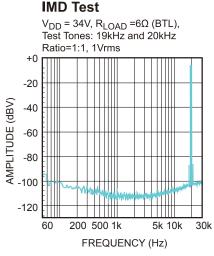
Circuit of Figure 7, bridge-tied-load output configuration,  $V_{DD}$ =34V,  $V_{EN}$ =5V,  $A_V$ =15V/V,  $T_A$  = +25°C, unless otherwise noted.

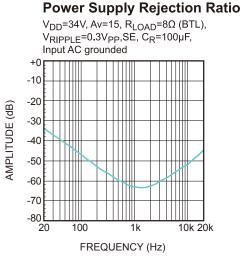


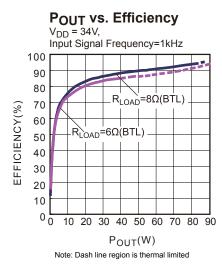


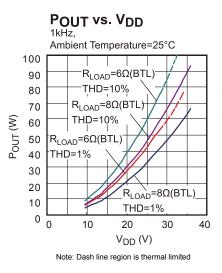
Circuit of Figure 7, bridge-tied-load output configuration,  $V_{DD}$ =34V,  $V_{EN}$ =5V,  $A_V$ =15V/V,  $T_A$  = +25°C, unless otherwise noted.

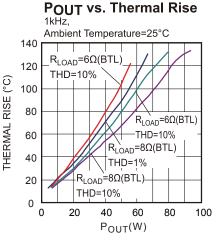












# **FUNCTIONAL BLOCK DIAGRAM**

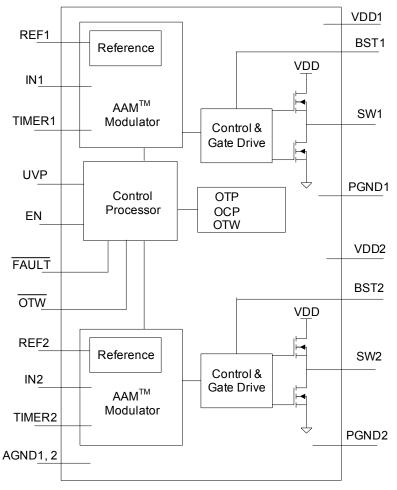


Figure 1: Functional Block Diagram



#### **OPERATION**

The MP7770 is a Class D Audio Amplifier that drives stereo speakers in single-ended configuration or a mono speaker in bridge-tied-load configuration. It uses MPS's patented Analog Adaptive Modulation™ technology to convert the audio input signal into pulses. These pulses drive an internal high-current output stage and—when filtered through an external inductor-capacitor filter—reproduce the input signal across the load. Because of the switching Class D output stage, power dissipation in the amplifier is drastically reduced when compared against Class A, B or A/B amplifiers, and maintains high fidelity with low distortion.

REF1 and REF2 are the positive inputs of the two amplifiers. They are set to half the DC power supply input voltage ( $V_{DD}/2$ ) by the internal circuit. The input capacitor  $C_{IN}$  decouples the AC signal at the input.

The input resister  $R_{\text{IN}}$  and the feedback resistor  $R_{\text{FB}}$  set the amplifier voltage gain as calculated by the equation:

$$AV = \frac{-R_{FB}}{R_{IN}}$$

Where:

- Channel 1: R<sub>FB</sub>=R<sub>FB1</sub> and R<sub>IN</sub>=R<sub>IN1</sub>
- Channel 2: R<sub>FB</sub>=R<sub>FB2</sub> and R<sub>IN</sub>=R<sub>IN2</sub>.

MP7770 includes The four high-power MOSFETs; For each channel, the output driver stage uses two 100mΩ N-channel MOSFETs to deliver pulses to the LC output filter to drive the load. To enhance the high-side MOSFET (HS-FET), the gate is driven to a voltage higher than the source by the bootstrap capacitor between SW and BS. When the output is low, the bootstrap capacitor is charged from V<sub>DD</sub> through an internal circuit on the MP7770. The gate of the HS-FET is driven high by the BST voltage, forcing the MOSFET gate to a voltage higher than V<sub>DD</sub>, thus allowing the MOSFET to turn on and reducing amplifier power loss.

#### Pop Elimination

When used in a single-ended output configuration, the capacitors  $C_{\text{OUT1}}$  and  $C_{\text{OUT2}}$  block the DC signal and pass the AC signals to the load. To insure that the amplifier only passes low-frequency signals, the time constant of  $C_{\text{OUT}}^*R_{\text{LOAD}}$  is large. However, when EN goes high, the capacitor charges over a long period and can result in turn-on/turn-off "pop" In typical amplifiers.

The MP7770 integrates a source-current function to charge the DC block capacitors  $C_{\text{OUT1}}$  and  $C_{\text{OUT2}}$  and  $C_{\text{IN1}}$  and  $C_{\text{IN2}}$  at start-up. Two internally-generated currents flow to the SW pin ( $I_{\text{initialization}\_SW}$ ) and the IN pin ( $I_{\text{initialization}\_IN}$ ) during start-up, which helps to eliminate turn-on pop. The rising/falling slew rate of the SW node start-up current ( $I_{\text{initialization}\_SW}$ ) is out of audio band (means rise and falling gradually), can be adjusted from the timer capacitor  $C_{\text{TIMER}}$  and the voltage of SW node; The larger the  $C_{\text{TIMER}}$  capacitance, the smaller the slew rate of the  $I_{\text{initialization}\_SW}$ .

After driving the EN pin low, the output SW immediately switches to high impedance to eliminate turn-off pop.

# Short Circuit/Overload Protection and Monitoring

The MP7770 is fully-protected against overcurrent and thermal overload conditions as explained below and \shown in Figure 2.

#### Short Circuit/Overload Protection

The MP7770 has internal overload and short-circuit protection. The currents in both the high-side and low-side MOSFETs (LS-FETs) are measured and if the current exceeds the short circuit current limit (typically 8.5A), both MOSFETs will be turned off for a fixed duration (around 1ms) before resuming normal operation. After the fixed duration and the short circuit condition is removed, the MP7770 will restart with the start-up sequence that is used for normal starting to prevent a pop from occurring.



#### Over-Temperature Shutdown

Thermal monitoring is also integrated into the MP7770. If the die temperature rises above 150°C, all switches turn off. The temperature must fall below 130°C before normal operation resumes, with the same power-up sequence used to prevent popping noise.

#### Over-Temperature Warning Output

The MP7770 includes an open drain, active low fault indicator output to act as an over-temperature warning (OTW). The OTW pin is asserted when the die temperature reaches 125°C and goes low until the temperature drops below 115°C.

Do not apply more than 6V to the OTW pin.

#### **Fault Output**

The MP7770 includes an open drain, active low fault indicator output on the FAULTB pin. A fault triggers if either the current limit or thermal shutdown is tripped.

A fault on any channel will cause the FAULTB pin to pull low. A fault on either channel will cause the all outputs to go into high impedance. When the fault goes away, the MP7770 will resume normal operation.

Do not apply more than 6V to the FAULTB pin.

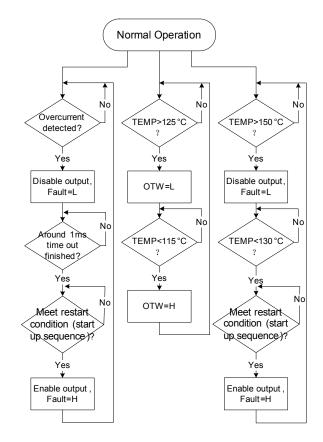


Figure 2: Fault Timing Chart

#### **Enable Function**

The MP7770 EN input is an active-high–enable control. To enable the MP7770, drive EN with a voltage 2.0V or higher; to disable the amplifier, drive it below 0.4V. While the MP7770 is disabled, the VDD operating current is around 250 $\mu$ A and the output driver MOSFETs are turned off.

#### **Programmable UVP**

MP7770 integrate programmable UVP function, which can be used to shutdown the MP7770 to escape the pop, by controlling the UVP node voltage. The VDD shutdown voltage can be flexibly adjusted by the external resistor, as shown in the figure 3.

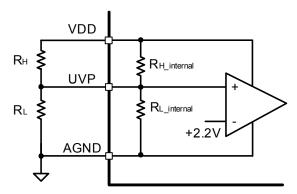


Figure 3: UVP Block Diagram

If external resistor  $R_H$  and  $R_L$  is low enough (e.g.  $R_H$ ,  $R_L$  < 50k $\Omega$ ) compared with internal resistor, the VDD shutdown voltage (rising threshold) can be calculated by the equation:

$$V_{\text{VDD\_shutdown}} \approx 2.2 * \frac{\left(R_{\text{H}} + R_{\text{L}}\right)}{R_{\text{L}}}$$

If the UVP pin is NC, the default VDD shutdown voltage (rising threshold) is 8.4V since there is internal voltage divided circuit.

For example, please see the table 1 for recommended UVP setting for reduce the power off pop.

Table 1

VDD (V)	VDD_shutdown (V)	R <sub>H</sub>	R <sub>L</sub>
12	8.6	15k	5.1k
24	19	39k	5.1k
36	26	56k	5.1k

#### APPLICATION INFORMATION

#### **Component Selection**

The MP7770 uses a minimal number of external components to complete a stereo SE or mono BTL Class D audio amplifier. The circuit in Figure 6 (stereo SE application circuit) and Figure 7 (mono BLT application circuit) are optimized for a 24V power supply. This circuit should be suitable for most applications. Use the following sections to design custom circuits.

#### **Setting the Voltage Gain**

The maximum output-voltage swing is limited by the power supply. To achieve the maximum output power, set the gain such that the maximum input signal results in the maximum output voltage swing.

For a single-ended (SE) output configuration, the maximum output voltage  $V_{\text{OUT}(PK)}$  is  $V_{\text{DD}}/2$ . For a bridge-tied-load (BTL) output configuration, the maximum output voltage  $V_{\text{OUT}(PK)}$  is  $V_{\text{DD}}$ . For a given input signal voltage, where  $V_{\text{IN}(PK)}$  is the peak input voltage, the maximum voltage gain is:

$$A_{V}(MAX) = \frac{V_{OUT(PK)}}{V_{IN(PK)}}$$

This voltage-gain setting results in the peak output voltage approaching its maximum for the maximum input signal. In some cases the amplifier is allowed to overdrive slightly, allowing the THD to increase at high power levels, and so a higher gain than  $A_V$  (max) is required.

#### **Setting the Switching Frequency**

The idle switching frequency (the switching frequency when no audio input is present) is a function of several variables: The supply voltage V<sub>DD</sub>, the integral capacitor C<sub>INT</sub> and the feedback resistor R<sub>FB</sub>. Lower switching frequencies result in greater inductor ripple, causing more quiescent output voltage ripple, and increasing the output noise and distortion. Higher switching frequencies result in greater power loss. The optimum quiescent switching frequency is approximately 600kHz. When used to drive stereo speakers in single-ended configuration, set right channel to an idle switching frequency

greater than 50kHz plus the left channel's switching frequency by using a different timing capacitor  $C_{\text{INT}}$ . For details, refer to the Table 2 for recommended SE output configuration design, and Table 3 for recommended BTL output configuration design.

Table 2: Switching Frequency Setting For SE Output Configuration

$V_{DD}$	Gain	R <sub>FB</sub>	Left Right Right channel					_
(V)	(V/V)	(kΩ)	(kΩ)	C <sub>INT1</sub> (nF)	F <sub>SW1</sub> (kHz)	C <sub>INT2</sub> (nF)	F <sub>SW2</sub> (kHz)	
12	10	100	10	2.2	635	1.8	705	
12	20	100	4.99	2.2	635	1.8	705	
24	10	75	7.5	5.6	700	4.7	740	
24	20	150	7.5	2.2	780	2.7	665	
30	10	51	5.1	8.2	780	10	680	
30	20	150	7.5	3.3	710	2.7	780	
30	30	150	4.99	3.3	710	2.7	780	
34	10	51	5.1	10	785	12	610	
34	20	100	4.99	4.7	780	5.6	740	
34	30	150	4.99	3.9	700	3.3	775	

Table 3: Switching Frequency Setting for BTL Output Configuration

V <sub>DD</sub> (V)	Gain (V/V)	R <sub>FB</sub> (kΩ)	R <sub>IN</sub> (kΩ)	C <sub>INT1</sub> (nF)	F <sub>SW1</sub> (kHz)
12	10	100	10	2.2	435
12	20	100	4.99	2.2	435
12	30	150	4.99	1.0	440
24	10	100	10	3.3	490
24	20	100	4.99	2.2	570
24	30	150	4.99	1.5	480
30	10	100	10	2.2	465
30	20	100	4.99	3.3	535
30	30	150	4.99	2.2	450
34	10	100	10	3.3	560
34	20	100	4.99	3.3	560
34	30	150	4.99	2.2	470

#### **Choosing the Output LC Filter**

The inductor-capacitor (LC) filter converts the pulses at SW to the output voltage that drives the speaker. There are two kinds of LC filter structure depending on the output configuration.

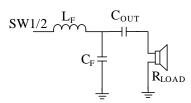


Figure 4: SE Filter Configuration

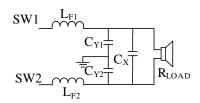


Figure 5: BTL Filter Configuration

Where:

$$\begin{split} L_F &= L_{F1} + L_{F2} \,, \\ C_F &= C_X + \frac{C_{Y1} \times C_{Y2}}{C_{Y1} + C_{Y2}} \,, \\ L_{F1} &= L_{F2} \,; \\ C_{Y1} &= C_{Y2} \end{split}$$

The characteristic frequency of the LC filter needs to be high enough to allow high frequency audio to the output, yet needs to be low enough to filter out high frequency products of the pulses from the SW pin. The characteristic frequency of the LC filter is:

$$f_0 = \frac{1}{2 \times \pi \times \sqrt{L_F \times C_F}}$$

The quality factor (Q) of the LC filter is important: If this is too low, output noise will increase; if this is too high, then peaking may occur at high frequencies and reduce the passband flatness. The circuit Q is set by the load resistance (speaker resistance, typically  $4\Omega$  or  $8\Omega$ ). Q is calculated as:

$$Q = \frac{R_{\text{LOAD}}}{\omega_0 \times L_{\text{F}}} = \frac{R_{\text{LOAD}}}{2\pi \times f_0 \times L_{\text{F}}}$$

 $\omega_0$  is the characteristic frequency in radians/second and  $f_0$  is in Hz. Use an LC filter with Q between 0.7 and 1.

The type of inductor and capacitor used in the LC filter.greatly affects the output ripple and noise. Use a film capacitor and an inductor with sufficient power rating to supply the output current to the load. The inductor must exhibit soft saturation characteristics: If the inductor exhibits hard saturation, it should operate well below the saturation current. Use toroidal cores made of gapped ferrite, MPP, powdered iron, or similar materials. If using either an open or shielded bobbin ferrite core for multi-channel designs, make sure that the start windings of each inductor align (all starting toward the SW pin, or all starting toward the output) to prevent crosstalk or other channel-to-channel interference.

#### **Output Coupling Capacitor for SE Output**

The output AC coupling capacitor— $C_{\text{OUT}}$ —serves to pass only the amplified AC signal from the LC filter to the load and to block DC signals. The combination of the coupling capacitor,  $C_{\text{OUT}}$  and the load resistance results in a first-order high-pass filter. Select  $C_{\text{OUT}}$  so that the required minimum frequency passes. The output corner frequency (-3dB point),  $f_{\text{OUT}}$ , can be calculated as:

$$f_{OUT} = \frac{1}{2 \times \pi \times R_{LOAD} \times C_{OUT}}$$

Set the output corner frequency ( $f_{\text{OUT}}$ ) at or below the minimum required frequency.

The output coupling capacitor carries the full load current, so chose a capacitor such that its ripple current rating is greater than the maximum load current. Use low-ESR aluminum electrolytic capacitors for best results.

#### **Input Coupling Capacitor**

The input coupling capacitors  $C_{\text{IN1}}$  and  $C_{\text{IN2}}$  pass only the AC signal at the input. For a typical system application, the source input signal centers around the circuit ground, while the MP7770 input is at half the power supply voltage ( $V_{\text{DD}}/2$ ). The input coupling capacitor transmits the AC signal from the source



to the MP7770 while blocking the DC voltage. Choose an input coupling capacitor such that the corner frequency ( $f_{\text{IN}}$ ) is less than the passband frequency. The corner frequency is calculated as:

$$f_{IN} = \frac{1}{2 \times \pi \times R_{IN} \times C_{IN}}$$

#### **Timer capacitor**

The start-up source current slew rate is adjusted from the timing capacitor,  $C_{\text{TIMER}}$ : The larger the  $C_{\text{TIMER}}$  capacitance is, the smaller the start-up current slew rate is. Select a  $C_{\text{TIMER}}$  value larger than 470nF, so the start-up current slew rate would be smaller than 15mA/200ms which helps eliminate the turn-on pop. The recommended 1 $\mu$ F capacitor  $C_{\text{TIMER}}$  results in a start-up current slew rate of approximately 15mA/400ms.

#### **Power Source**

For maximum output power, the amplifier circuit requires a regulated external power source. A high power-supply voltage can deliver more power to a given load resistance, but a power-source voltage exceeding the maximum voltage of 36V can damage the MP7770. The MP7770's power supply rejection is excellent, though power-supply noise can pass to the output, so care must be taken to minimize power supply noise within the pass-band frequencies. Bypass the power supply with a large capacitor (typically aluminum electrolytic) along with a smaller  $1\mu F$  ceramic capacitor at the MP7770  $V_{\text{DD}}$  supply pins.

#### **PCB Layout**

Circuit layout is critical for optimal performance, low output distortion, and noise. Duplicate the EVB layout for best results. For layout changes, follow these guidelines and use Figure 8 as SE layout references, use Figure 9 as BTL layout reference.

1) Place the following components as close to the MP7770 as possible:

#### **Bootstrap Capacitors**

 $C_{BS1}$  and  $C_{BS2}$  supply the gate drive current to the internal HS-FET. Place  $C_{BS1}$  as close to BST1/2 pin and SW1/2 pin as possible. Likewise, place  $C_{BS2}$  as close to BST2 pin and SW2 pins as possible.

#### Power Supply Bypass Capacitors

 $C_{\text{BYP1}}$  and  $C_{\text{BYP2}}$  carry the transient current for the switching power stage. To avoid overstressing the MP7770 and excessive output noise, place  $C_{\text{BYP1}}$  as close to the VDD1 pins and PGND1 pins as possible, and place  $C_{\text{BYP2}}$  as close to the VDD2 pins and PGND2 pins as possible.

#### **Integral Capacitors**

 $C_{\mathsf{INT}}$  sets the amplifier switching frequencies and are typically on the order of a few nF. Place the integral capacitor  $C_{\mathsf{INT}}$  as close to the corresponding input as possible to reduce distortion and noise. For example, place  $C_{\mathsf{INT1}}$  as close to pins 2 and 3 as possible at SE output configuration.

Reference Bypass Capacitors for SE Output When used with SE output, CR1 and CR2 filter the  $\frac{1}{2}$  VDD reference voltages. Place  $C_{R1}$  and  $C_{R2}$  as close to the IC as possible to improve power supply rejection and reduce distortion and noise at the output.

- 2) The Inductor-Capacitor (LC) filter converts the pulse train at SW to the output voltage that drives the speaker. Please keep the filter capacitor close to the inductor.
- 3) Keep the sensitive feedback signal trace on the input side and shield the trace with the AGND plane. Make sure that any traces carrying the switch node (SW) voltages are routed far from any input signal traces. If the trace must run near the SW trace near the input, shield the input with a ground plane between the traces. Physically separate each channel to



prevent crosstalk. Make sure that all inductors used on a single circuit board have the same orientation.

Route each power supply from the source to each channel individually, not serially. This prevents channel-to-channel coupling through the power supply input.

# Electro-Magnetic Interference (EMI) Considerations

Due to the switching nature of Class D amplifiers, care must be taken to minimize the effects of electromagnetic interference from the amplifier. However, proper component selection and careful attention to circuit layout can minimize the effects of the EMI due to the amplifier switching.

The power inductors are a potential source of radiated emissions. For the best performance, use toroidal inductors, since the magnetic field is well-contained inside the core. However toroidal inductors can be expensive to wind. For a more economical solution, use shielded-gapped-ferrite or shielded-ferritebobbin-core inductors. These inductors typically do not contain the EM field as well toroidal inductors, but can achieve a better balance between good EMI performance with low cost.

The size of high-current loops that carry rapidly changing currents must be minimized: Make sure that the  $V_{DD}$  bypass capacitors are as close to the MP7770 as possible.

Nodes that carry rapidly changing voltage, such as SW, need to be made as small as possible. If sensitive traces run near a trace connected to SW, place a ground shield between the traces.



# TYPICAL APPLICATION CIRCUITS

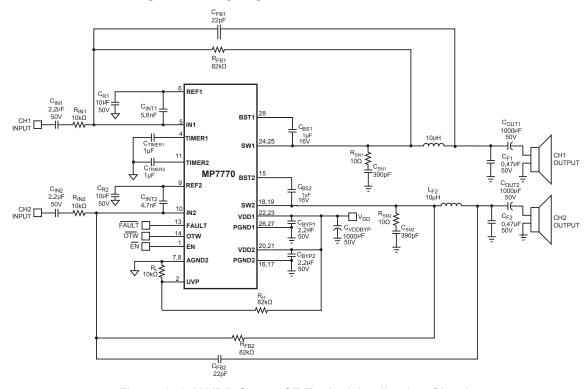


Figure 6: 24V VDD Stereo SE Typical Application Circuit

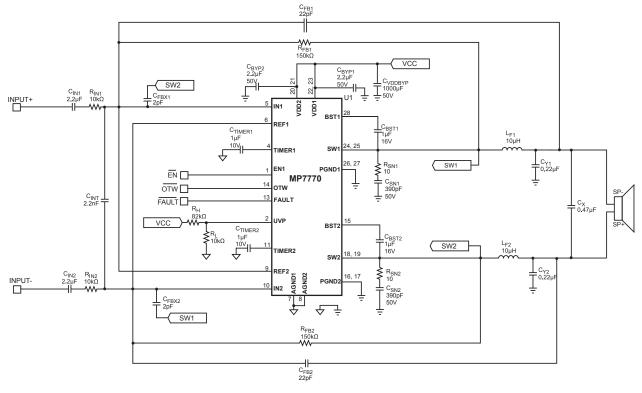
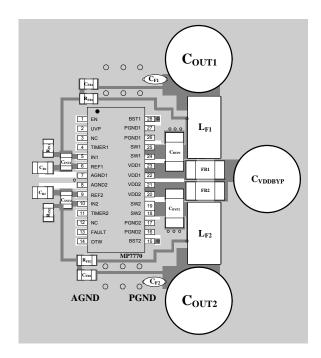
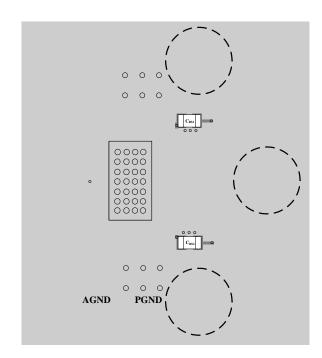


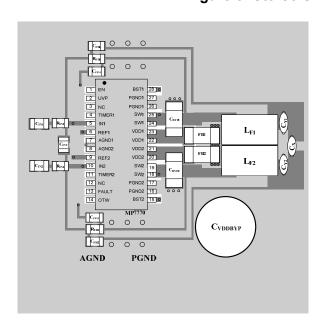
Figure 7: 24V VDD Mono BTL Typical Application Circuit

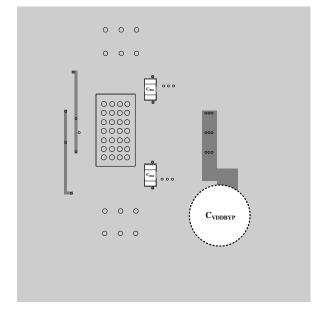




Top Bottom

Figure 8: Stereo SE Reference PCB Layout





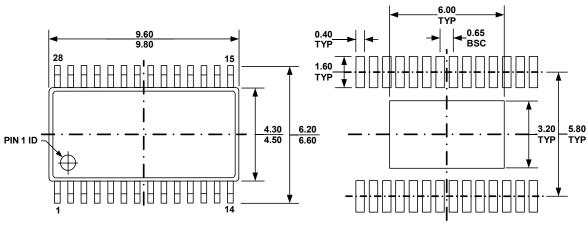
Top Bottom

Figure 9: Mono BTL Reference PCB Layout



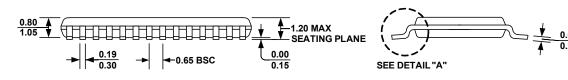
# **PACKAGE INFORMATION**

#### TSSOP28-EP



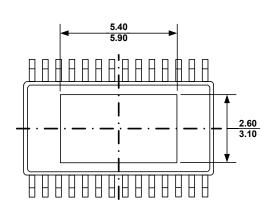
**TOP VIEW** 

**RECOMMENDED LAND PATTERN** 

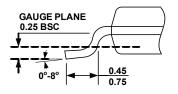


**FRONT VIEW** 

**SIDE VIEW** 



**BOTTOM VIEW** 



**DETAIL "A"** 

#### NOTE:

- 1) ALL DIMENSIONS ARE IN MILLIMETERS
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH PROTRUSION OR GATE BURR
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.
- 4) LEAD COPLANARITY(BOTTOM OF LEADS AFTER FORMING SHALL BE 0.10 MILLIMETERS MAX
  5) DRAWING CONFORMS TO JEDEC MO153, VARIATION AET.
- 6) DRAWING IS NOT TO SCALE

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